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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	F ² MC-16LX
Core Size	16-Bit
Speed	24MHz
Connectivity	CANbus, EBI/EMI, LINbus, SCI, UART/USART
Peripherals	DMA, POR, WDT
Number of I/O	80
Program Memory Size	128KB (128K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	A/D 16x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90347epmc-gs-745e1

1. Product Lineup

Part Number			
Parameter	MB90V340E-101, MB90V340E-102	MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90F346E(S), MB90F346CE(S), MB90F347E(S), MB90F347CE(S), MB90F349E(S), MB90F349CE(S)	MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90346E(S), MB90346CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S)
Type	Evaluation products	Flash memory products	MASK ROM products
CPU	F ² MC-16LX CPU		
System clock	On-chip PLL clock multiplier (×1, ×2, ×3, ×4, ×6, 1/2 when PLL stops) Minimum instruction execution time : 42 ns (4 MHz osc. PLL × 6)		
ROM	External	512 Kbytes : MB90F345E(S), MB90F345CE(S) 256 Kbytes : MB90F342E(S), MB90F342CE(S), MB90F349E(S), MB90F349CE(S) 128 Kbytes : MB90F347E(S), MB90F347CE(S) 64 Kbytes : MB90F346E(S), MB90F346CE(S)	256 Kbytes : MB90342E(S), MB90342CE(S), MB90349E(S), MB90349CE(S) 128 Kbytes : MB90341E(S), MB90341CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S) 64 Kbytes : MB90346E(S), MB90346CE(S)
RAM	30 Kbytes	20 Kbytes : MB90F345E(S), MB90F345CE(S) 16 Kbytes : MB90F342E(S), MB90F342CE(S), MB90F349E(S), MB90F349CE(S) 6 Kbytes : MB90F347E(S), MB90F347CE(S) 2 Kbytes : MB90F346E(S), MB90F346CE(S)	16 Kbytes : MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S) 6 Kbytes : MB90347E(S), MB90347CE(S) 2 Kbytes : MB90346E(S), MB90346CE(S)
Emulator-specific power supply*	Yes	—	
Technology	0.35 μm CMOS with regulator for built-in power supply	0.35 μm CMOS with built-in power supply regulator + Flash memory with Charge pump for programming voltage	
Operating voltage range	5 V ± 10%	3.5 V to 5.5 V : When normal operating (not using A/D converter) 4.0 V to 5.5 V : When using the A/D converter/Flash programming 4.5 V to 5.5 V : When using the external bus	
Temperature range	—	−40°C to +105°C	
Package	PGA-299	QFP-100, LQFP-100	
LIN-UART	5 channels	4 channels	
	Wide range of baud rate settings using a dedicated baud rate generator (reload timer) Special synchronous options for adapting to different synchronous serial protocols LIN functionality working either as master or slave LIN device		
I ² C (400 kbps)	2 channels	Devices with a C suffix in the part number : 2 channels Devices without a C suffix in the part number : —	

(Continued)

Part Number			
Parameter	MB90V340E-101, MB90V340E-102	MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90F346E(S), MB90F346CE(S), MB90F347E(S), MB90F347CE(S), MB90F349E(S), MB90F349CE(S)	MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90346E(S), MB90346CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S)
A/D Converter	24 input channels	Devices with a C suffix in the part number : 24 channels Devices without a C suffix in the part number : 16 channels	
	10-bit or 8-bit resolution Conversion time : Min 3 μs include sample time (per one channel)		
16-bit Reload Timer (4 channels)	Operation clock frequency : fsys/2 ¹ , fsys/2 ³ , fsys/2 ⁵ (fsys = Machine clock frequency) Supports External Event Count function		
16-bit Free-run Timer (2 channels)	Generates an interrupt signal on overflow Supports Timer Clear when the output compare finds a match Operation clock freq. : fsys, fsys/2 ¹ , fsys/2 ² , fsys/2 ³ , fsys/2 ⁴ , fsys/2 ⁵ , fsys/2 ⁶ , fsys/2 ⁷ (fsys = Machine clock freq.) Free-run Timer 0 (clock input FRCK0) corresponds to ICU 0/1/2/3, OCU 0/1/2/3 Free-run Timer 1 (clock input FRCK1) corresponds to ICU 4/5/6/7, OCU 4/5/6/7		
16-bit Output Compare (8 channels)	Generates an interrupt signal when one of the 16-bit free-run timer matches the output compare register A pair of compare registers can be used to generate an output signal.		
16-bit Input Capture (8 channels)	Captures the value of the 16-bit free-run timer and generates an interrupt when triggered by a pin input (rising edge, falling edge, or both rising and falling edges).		
8/16-bit Programmable Pulse Generator	8 channels (16-bit) /16 channels (8-bit) Sixteen 8-bit reload counters Sixteen 8-bit reload registers for L pulse width Sixteen 8-bit reload registers for H pulse width		
	Supports 8-bit and 16-bit operation modes A pair of 8-bit reload counters can be configured as one 16-bit reload counter or as 8-bit prescaler plus 8-bit reload counter Operating clock freq. : fsys, fsys/2 ¹ , fsys/2 ² , fsys/2 ³ , fsys/2 ⁴ or 128 μs@fosc = 4 MHz (fsys = Machine clock frequency, fosc = Oscillation clock frequency)		
CAN Interface	3 channels	2 channels : MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S) 1 channel : MB90F346E(S), MB90F346CE(S), MB90F347E(S), MB90F347CE(S), MB90F349E(S), MB90F349CE(S)	2 channels : MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S) 1 channel : MB90346E(S), MB90346CE(S), MB90347E(S), MB90347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S)
	Conforms to CAN Specification Version 2.0 Part A and B Automatic re-transmission in case of error Automatic transmission in response to Remote Frames Prioritized 16 message buffers for data and ID's Supports multiple messages Flexible configuration of acceptance filtering : Full bit compare/Full bit mask/Two partial bit masks Supports up to 1 Mbps		

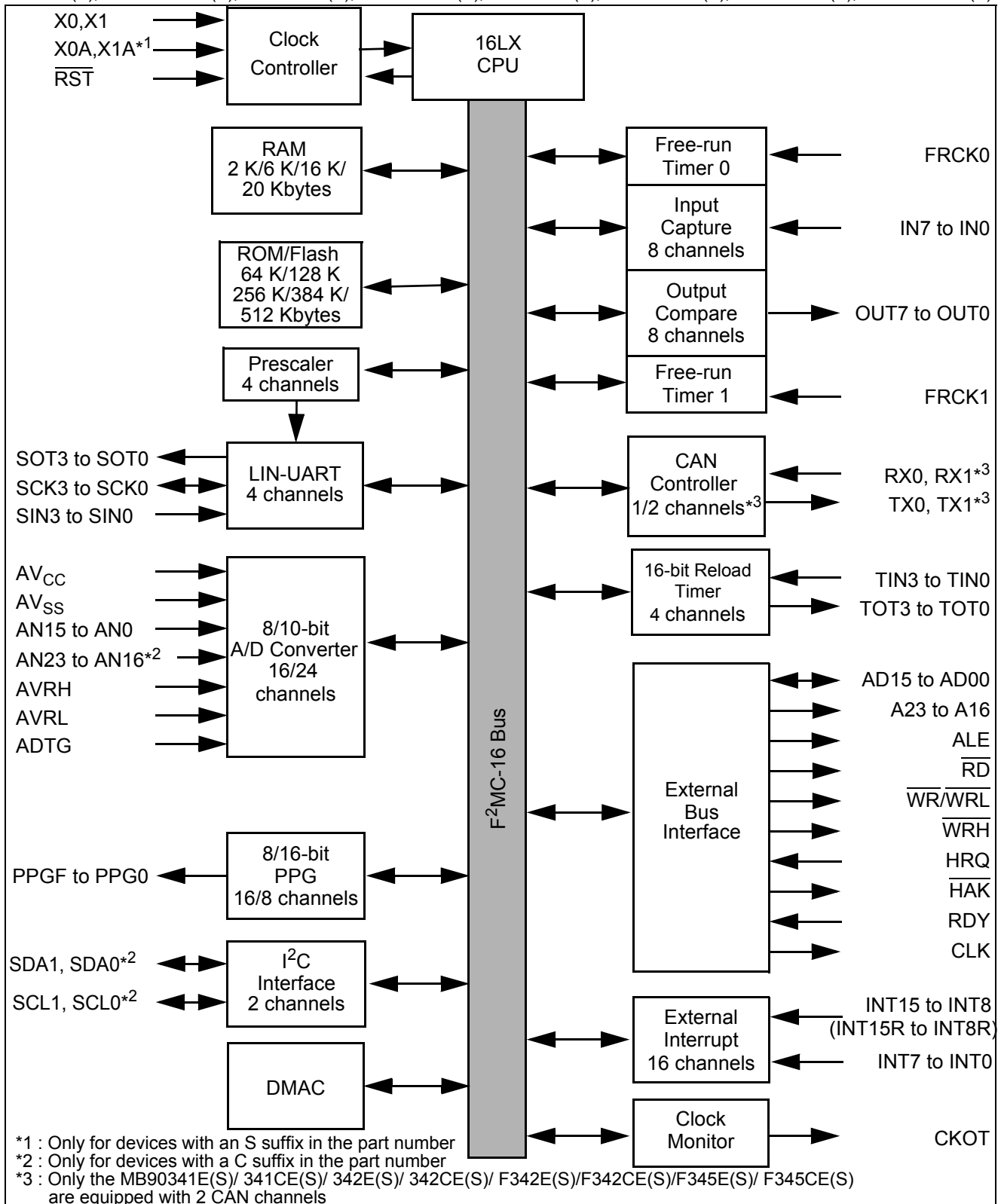
Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
9	7	P34	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or when the hold function is disabled.
		HRQ		Hold request input pin. This function is enabled when both the external bus and the hold function are enabled.
		OUT4		Waveform output pin for output compare.
10	8	P35	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or when the hold function is disabled.
		$\overline{\text{HAK}}$		Hold acknowledge output pin. This function is enabled when both the external bus and the hold function are enabled.
		OUT5		Waveform output pin for output compare.
11	9	P36	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or when the external ready function is disabled.
		RDY		External ready input pin. This function is enabled when both the external bus and the external ready function are enabled.
		OUT6		Waveform output pin for output compare.
12	10	P37	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled either in single-chip mode or when the clock output is disabled.
		CLK		Clock output pin. This function is enabled when both the external bus and clock output are enabled.
		OUT7		Waveform output pin for output compare
13, 14	11, 12	P40, P41	F	General purpose I/O pins. (devices with an S suffix in the part number and or MB90V340E-101)
		X0A, X1A	B	Oscillation pins for sub clock (devices without an S suffix in the part number and or MB90V340E-102)
15	13	V _{CC}	—	Power (3.5 V to 5.5 V) input pin
16	14	V _{SS}	—	GND pin
17	15	C	K	This is the power supply stabilization capacitor This pin should be connected to a ceramic capacitor with a capacitance greater than or equal to 0.1 μF .
18	16	P42	F	General purpose I/O pin.
		IN6		Trigger input pin for input capture.
		RX1		RX input pin for CAN1 Interface (MB90341E/342E/F342E/F345E only)
		INT9R		External interrupt request input pin

(Continued)


Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
61	59	P84	F	General purpose I/O pin.
		SCK0		Clock I/O pin for UART0
		INT15R		External interrupt request input pin
62	60	P85	M	General purpose I/O pin.
		SIN1		Serial data input pin for UART1
63	61	P86	F	General purpose I/O pin.
		SOT1		Serial data output pin for UART1
64	62	P87	F	General purpose I/O pin.
		SCK1		Clock I/O pin for UART1
65	63	V _{CC}	—	Power (3.5 V to 5.5 V) input pin
66	64	V _{SS}	—	GND pin
67 to 70	65 to 68	P90 to P93	F	General purpose I/O pins
		PPG1, 3, 5, 7		Output pins for PPGs
71 to 74	69 to 72	P94 to P97	F	General purpose I/O pins
		OUT0 to OUT3		Waveform output pins for output compares. This function is enabled when the OCU enables waveform output.
75	73	PA0	F	General purpose I/O pin.
		RX0		RX input pin for CAN0 Interface
		INT8R		External interrupt request input pin
76	74	PA1	F	General purpose I/O pin.
		TX0		TX Output pin for CAN0
77 to 84	75 to 82	P00 to P07	G	General purpose I/O pins. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD00 to AD07		I/O pins for 8 lower bits of the external address/data bus. This function is enabled when the external bus is enabled.
		INT8 to INT15		External interrupt request input pins.
85	83	P10	G	General purpose I/O pin. The register can be set to select whether to use a pull-up resistor. This function is enabled in single-chip mode.
		AD08		I/O pin for the external address/data bus. This function is enabled when the external bus is enabled.
		TIN1		Event input pin for the reload timer


(Continued)

■ MB90341E(S), MB90341CE(S), MB90342E(S), MB90342CE(S), MB90F342E(S), MB90F342CE(S), MB90F345E(S), MB90F345CE(S), MB90346E(S), MB90346CE(S), MB90F346E(S), MB90F346CE(S), MB90347E(S), MB90347CE(S), MB90F347E(S), MB90F347CE(S), MB90348E(S), MB90348CE(S), MB90349E(S), MB90349CE(S), MB90F349E(S), MB90F349CE(S)



7. Memory Map

MB90V340E-101/102		MB90F345E(S)/F345CE(S)	
000000H	Peripheral	000000H	Peripheral
0000EFH	External access area	0000EFH	External access area
000100H	RAM 30 Kbytes	000100H	RAM 20 Kbytes
0078FFH	Peripheral	0050FFH	
007900H		007900H	
007FFFH	ROM (image of FF bank)	007FFFH	Peripheral
008000H		008000H	
00FFFFH	External access area	00FFFFH	ROM (image of FF bank)
F80000H	ROM (F8 bank)	F80000H	External access area
F8FFFFH	ROM (F9 bank)	F8FFFFH	ROM (F8 bank)
F90000H		F90000H	ROM (F9 bank)
F9FFFFH	ROM (FA bank)	F9FFFFH	ROM (F9 bank)
FA0000H		FA0000H	ROM (FA bank)
FAFFFFH	ROM (FB bank)	FAFFFFH	ROM (FA bank)
FB0000H		FB0000H	ROM (FB bank)
FBFFFFH	ROM (FC bank)	FBFFFFH	ROM (FB bank)
FC0000H		FC0000H	ROM (FC bank)
FCFFFFH	ROM (FD bank)	FCFFFFH	ROM (FC bank)
FD0000H		FD0000H	ROM (FD bank)
FDFFFFH	ROM (FE bank)	FDFFFFH	ROM (FD bank)
FE0000H		FE0000H	ROM (FE bank)
FEFFFFH	ROM (FF bank)	FEFFFFH	ROM (FE bank)
FF0000H		FF0000H	ROM (FF bank)
FFFFFFH	ROM (FF bank)	FFFFFFH	ROM (FF bank)

 : Not accessible

11.4 AC Characteristics

11.4.1 Clock Timing

($T_A = -40^{\circ}\text{C}$ to $+105^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $f_{CP} \leq 24\text{ MHz}$, $V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Clock frequency	f_C	X0, X1	3	—	16	MHz	When using an oscillation circuit
			4	—	16	MHz	PLL multiplied by 1 When using an oscillation circuit
			4	—	12	MHz	PLL multiplied by 2 When using an oscillation circuit
			4	—	8	MHz	PLL multiplied by 3 When using an oscillation circuit
			4	—	6	MHz	PLL multiplied by 4 When using an oscillation circuit
			—	—	4	MHz	PLL multiplied by 6 When using an oscillation circuit
			3	—	24	MHz	When using an external clock*
	f_{CL}	X0A, X1A	—	32.768	100	kHz	
Clock cycle time	t_{CYL}	X0, X1	62.5	—	333	ns	When using an oscillation circuit
		X0, X1	41.67	—	333	ns	When using an external clock
	t_{CYLL}	X0A, X1A	10	30.5	—	μs	
Input clock pulse width	P_{WH}, P_{WL}	X0	10	—	—	ns	Duty ratio is about 30% to 70%.
	P_{WHL}, P_{WLL}	X0A	5	15.2	—	μs	
Input clock rise and fall time	t_{CR}, t_{CF}	X0	—	—	5	ns	When using external clock
Internal operating clock frequency (machine clock)	f_{CP}	—	1.5	—	24	MHz	When using main clock
	f_{CPL}	—	—	8.192	50	kHz	When using sub clock
Internal operating clock cycle time (machine clock)	t_{CP}	—	41.67	—	666	ns	When using main clock
	t_{CPL}	—	20	122.1	—	μs	When using sub clock

* : When selecting the PLL clock, the range of clock frequency is limited. Use this product within the range as mentioned in “Relation between the external clock frequency and machine clock frequency”.

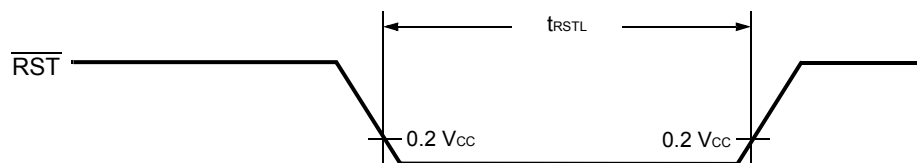
11.4.2 Reset Standby Input

($T_A = -40^\circ\text{C}$ to $+105^\circ\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $f_{CP} \leq 24\text{ MHz}$, $V_{SS} = AV_{SS} = 0.0\text{ V}$)

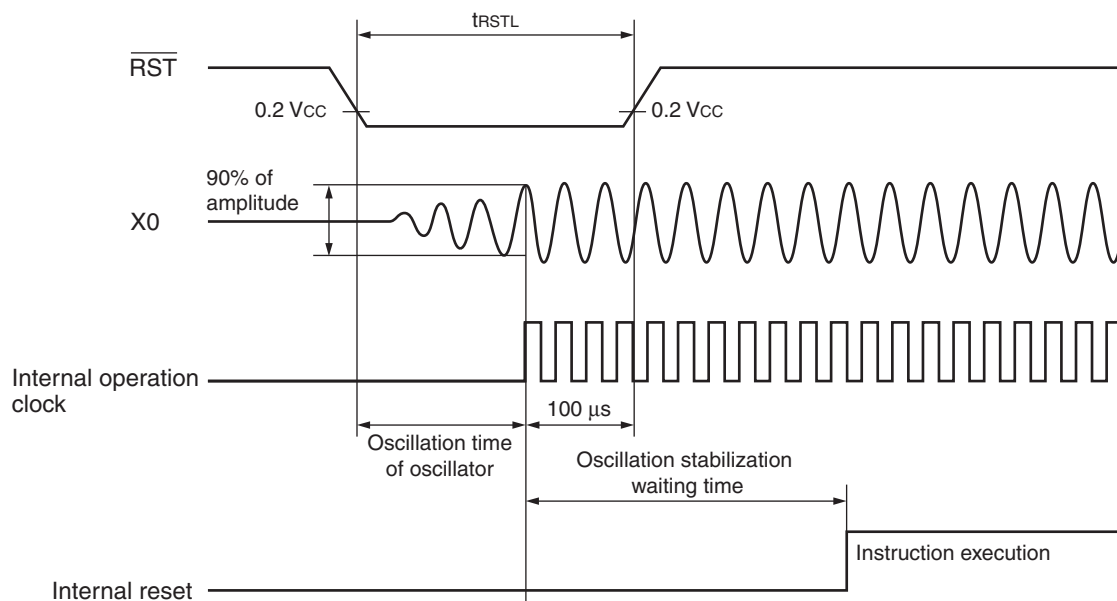
Parameter	Symbol	Pin	Value		Unit	Remarks
			Min	Max		
Reset input time	t_{RSTL}	$\overline{\text{RST}}$	500	—	ns	Under normal operation
			Oscillation time of oscillator* + 100 μs	—	μs	In Stop mode, Sub Clock mode, Sub Sleep mode and Watch mode
			100	—	μs	In Time Timer mode

* : The oscillation time of the oscillator is the time it takes for the amplitude of the oscillations to reach 90%. For crystal oscillators, this time is between several ms and several tens of ms, for ceramic oscillators the time is between several hundred μs and several ms, and for an external clock, the time is 0 ms.

● Under normal operation:



● In Stop mode, Sub Clock mode, Sub Sleep mode, Watch mode:

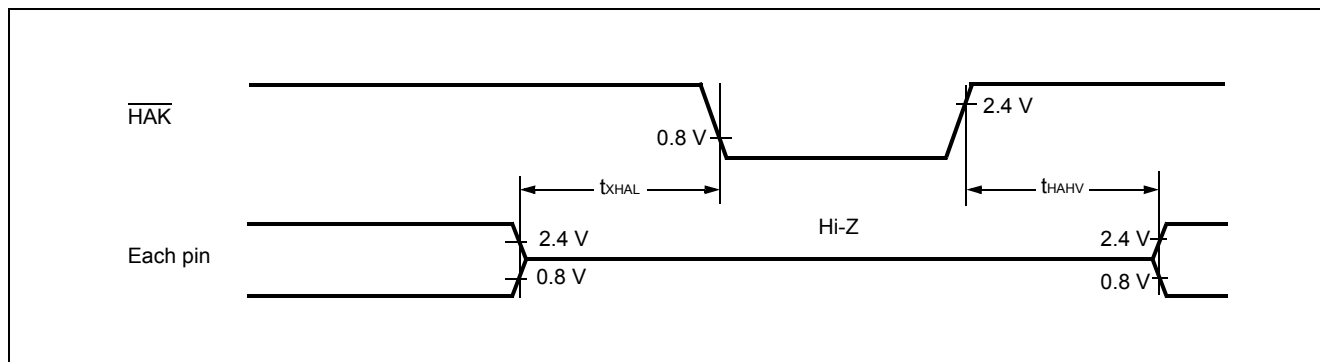


11.4.8 Hold Timing

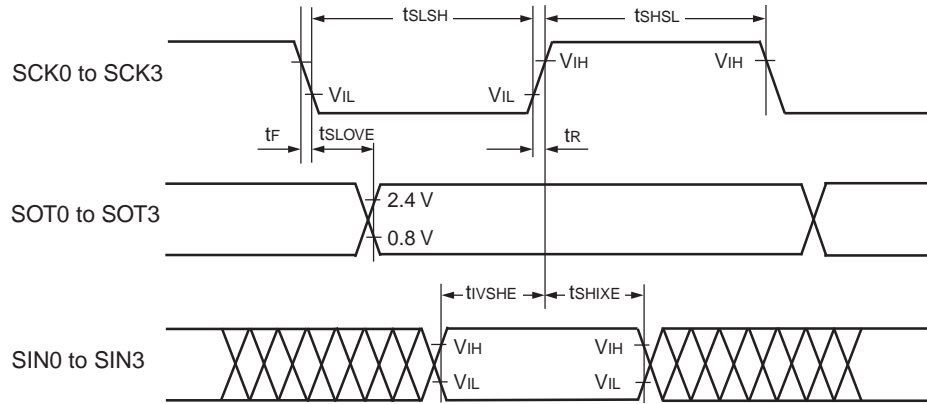
($T_A = -40^{\circ}\text{C}$ to $+105^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $f_{CP} \leq 24\text{ MHz}$)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Pin floating $\rightarrow \overline{\text{HAK}} \downarrow$ time	t_{XHAL}	$\overline{\text{HAK}}$	—	30	t_{CP}	ns
$\overline{\text{HAK}} \uparrow$ time \rightarrow Pin valid time	t_{HAHV}	$\overline{\text{HAK}}$	—	t_{CP}	$2 t_{CP}$	ns

Note: : There is more than 1 cycle from when HRQ reads in until the $\overline{\text{HAK}}$ is changed.



• External Shift Clock Mode



■ Bit setting: ESCR:SCES = 1, ECCR:SCDE = 0

($T_A = -40^\circ\text{C}$ to $+105^\circ\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $f_{CP} \leq 24\text{ MHz}$, $V_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal shift clock mode output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$5 t_{CP}$	—	ns
SCK $\uparrow \rightarrow$ SOT delay time	t_{SHOVI}	SCK0 to SCK3, SOT0 to SOT3		-50	+50	ns
Valid SIN \rightarrow SCK \downarrow	t_{IVSLI}	SCK0 to SCK3, SIN0 to SIN3		$t_{CP} + 80$	—	ns
SCK $\downarrow \rightarrow$ Valid SIN hold time	t_{SLIXI}	SCK0 to SCK3, SIN0 to SIN3		0	—	ns
Serial clock "H" pulse width	t_{SHSL}	SCK0 to SCK3	External shift clock mode output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$3 t_{CP} - t_R$	—	ns
Serial clock "L" pulse width	t_{SLSH}	SCK0 to SCK3		$t_{CP} + 10$	—	ns
SCK $\uparrow \rightarrow$ SOT delay time	t_{SHOVE}	SCK0 to SCK3, SOT0 to SOT3		—	$2 t_{CP} + 60$	ns
Valid SIN \rightarrow SCK \downarrow	t_{IVSLE}	SCK0 to SCK3, SIN0 to SIN3		30	—	ns
SCK $\downarrow \rightarrow$ Valid SIN hold time	t_{SLIXE}	SCK0 to SCK3, SIN0 to SIN3		$t_{CP} + 30$	—	ns
SCK fall time	t_F	SCK0 to SCK3		—	10	ns
SCK rise time	t_R	SCK0 to SCK3		—	10	ns

Note:

- C_L is load capacity value of pins when testing.
- t_{CP} is internal operating clock cycle time (machine clock) . Refer to "Clock Timing".

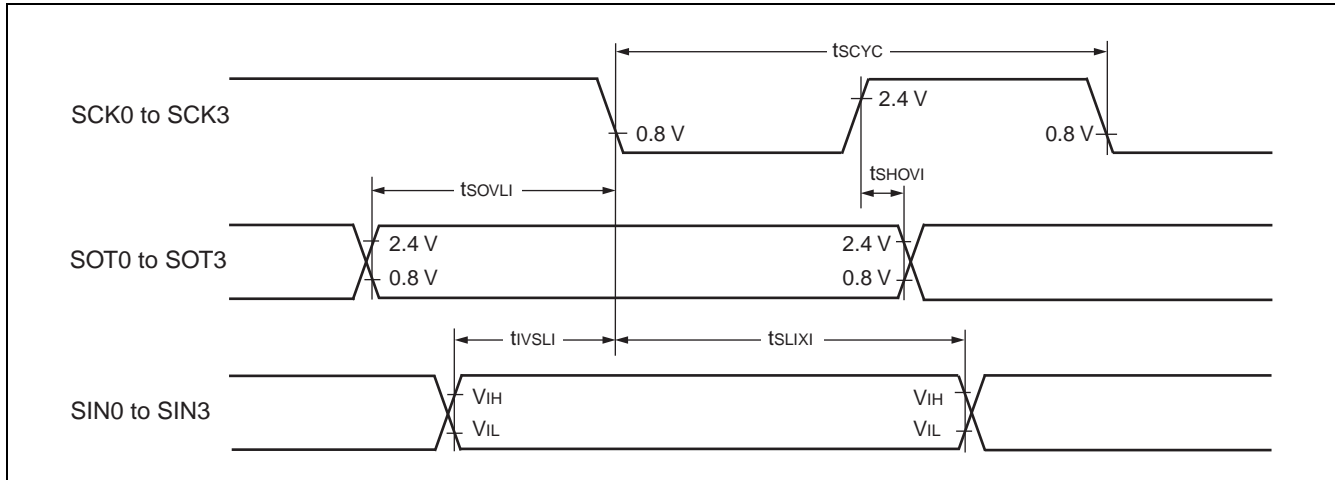
■ Bit setting: ESCR:SCES = 0, ECCR:SCDE = 1

($T_A = -40^\circ\text{C}$ to $+105^\circ\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $f_{CP} \leq 24\text{ MHz}$, $V_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	SCK0 to SCK3	Internal clock operation output pins are $C_L = 80\text{ pF} + 1\text{ TTL}$.	$5 t_{CP}$	—	ns
SCK $\uparrow \rightarrow$ SOT delay time	t_{SHOVI}	SCK0 to SCK3, SOT0 to SOT3		-50	+50	ns
Valid SIN \rightarrow SCK \downarrow	t_{IVSLI}	SCK0 to SCK3, SIN0 to SIN3		$t_{CP} + 80$	—	ns
SCK $\downarrow \rightarrow$ Valid SIN hold time	t_{SLIXI}	SCK0 to SCK3, SIN0 to SIN3		0	—	ns
SOT \rightarrow SCK \downarrow delay time	t_{SOVLI}	SCK0 to SCK3, SOT0 to SOT3		$3 t_{CP} - 70$	—	ns

Note:

- C_L is load capacity value of pins when testing.
- t_{CP} is internal operating clock cycle time (machine clock) . Refer to “Clock Timing”.



11.4.13 I²C Timing

(T_A = -40°C to +105°C, V_{CC} = 5.0 V ± 10%, V_{SS} = 0.0 V)

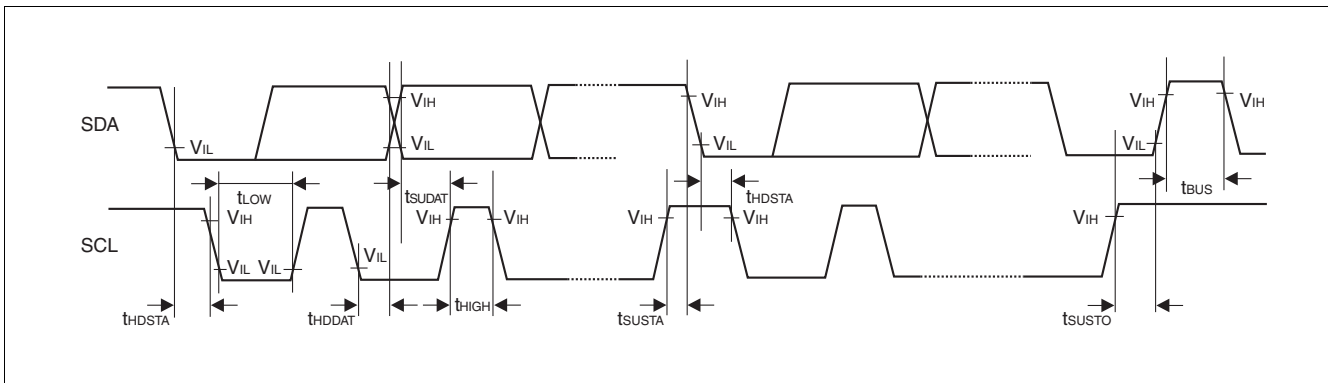
Parameter	Symbol	Condition	Standard-mode		Fast-mode* ¹		Unit
			Min	Max	Min	Max	
SCL clock frequency	f _{SCL}	R = 1.7 kΩ ₂ C = 50 pF* ²	0	100	0	400	kHz
Hold time (repeated) START condition SDA ↓ → SCL ↓	t _{HDSTA}		4.0	—	0.6	—	μs
"L" width of the SCL clock	t _{LOW}		4.7	—	1.3	—	μs
"H" width of the SCL clock	t _{HIGH}		4.0	—	0.6	—	μs
Set-up time (repeated) START condition SCL ↑ → SDA ↓	t _{SUSTA}		4.7	—	0.6	—	μs
Data hold time SCL ↓ → SDA ↓ ↑	t _{HDDAT}		0	3.45* ³	0	0.9* ⁴	μs
Data set-up time SDA ↓ ↑ → SCL ↑	t _{SUDAT}		250	—	100	—	ns
Set-up time for STOP condition SCL ↑ → SDA ↑	t _{SUSTO}		4.0	—	0.6	—	μs
Bus free time between a STOP and START condition	t _{BUS}		4.7	—	1.3	—	μs

*1: For use at over 100 kHz, set the machine clock to at least 6 MHz.

*2: R, C: Pull-up resistor and load capacitor of the SCL and SDA lines.

*3: The maximum t_{HDDAT} meets the requirement that it does not extend the "L" width (t_{LOW}) of the SCL signal.

*4: A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system, but the requirement t_{SUDAT} ≥ 250 ns must then be met.



11.5 A/D Converter

($T_A = -40^\circ\text{C}$ to $+105^\circ\text{C}$, $3.0\text{ V} \leq \text{AVRH} - \text{AVRL}$, $V_{CC} = \text{AV}_{CC} = 5.0\text{ V} \pm 10\%$, $f_{CP} \leq 24\text{ MHz}$, $V_{SS} = \text{AV}_{SS} = 0\text{ V}$)

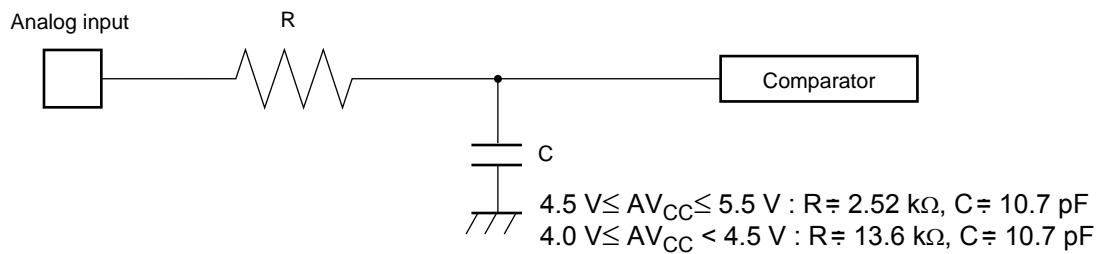
Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Total error	—	—	—	—	± 3.0	LSB	
Nonlinearity error	—	—	—	—	± 2.5	LSB	
Differential nonlinearity error	—	—	—	—	± 1.9	LSB	
Zero reading voltage	V_{OT}	AN0 to AN23	$\text{AVRL} - 1.5 \times \text{LSB}$	$\text{AVRL} + 0.5 \times \text{LSB}$	$\text{AVRL} + 2.5 \times \text{LSB}$	V	
Full scale reading voltage	V_{FST}	AN0 to AN23	$\text{AVRH} - 3.5 \times \text{LSB}$	$\text{AVRH} - 1.5 \times \text{LSB}$	$\text{AVRH} + 0.5 \times \text{LSB}$	V	
Compare time	—	—	1.0	—	16500	μs	$4.5\text{ V} \leq \text{AV}_{CC} \leq 5.5\text{ V}$
			2.0				$4.0\text{ V} \leq \text{AV}_{CC} < 4.5\text{ V}$
Sampling time	—	—	0.5	—	∞	μs	$4.5\text{ V} \leq \text{AV}_{CC} \leq 5.5\text{ V}$
			1.2				$4.0\text{ V} \leq \text{AV}_{CC} < 4.5\text{ V}$
Analog port input current	I_{AIN}	AN0 to AN23	-0.3	—	+0.3	μA	
Analog input voltage range	V_{AIN}	AN0 to AN23	AVRL	—	AVRH	V	
Reference voltage range	—	AVRH	$\text{AVRL} + 2.7$	—	AV_{CC}	V	
	—	AVRL	0	—	$\text{AVRH} - 2.7$	V	
Power supply current	I_A	AV_{CC}	—	3.5	7.5	mA	
	I_{AH}	AV_{CC}	—	—	5	μA	*
Reference voltage current	I_R	AVRH	—	600	900	μA	
	I_{RH}	AVRH	—	—	5	μA	*
Offset between input channels	—	AN0 to AN23	—	—	4	LSB	

*: If the A/D convertor is not operating, a current when CPU is stopped is applicable ($V_{CC} = \text{AV}_{CC} = \text{AVRH} = 5.0\text{ V}$).

Note: : The accuracy gets worse as $|\text{AVRH} - \text{AVRL}|$ becomes smaller.

If the output impedance of the external circuit is too high, a sampling period for an analog voltage may be insufficient.

• Analog input circuit model



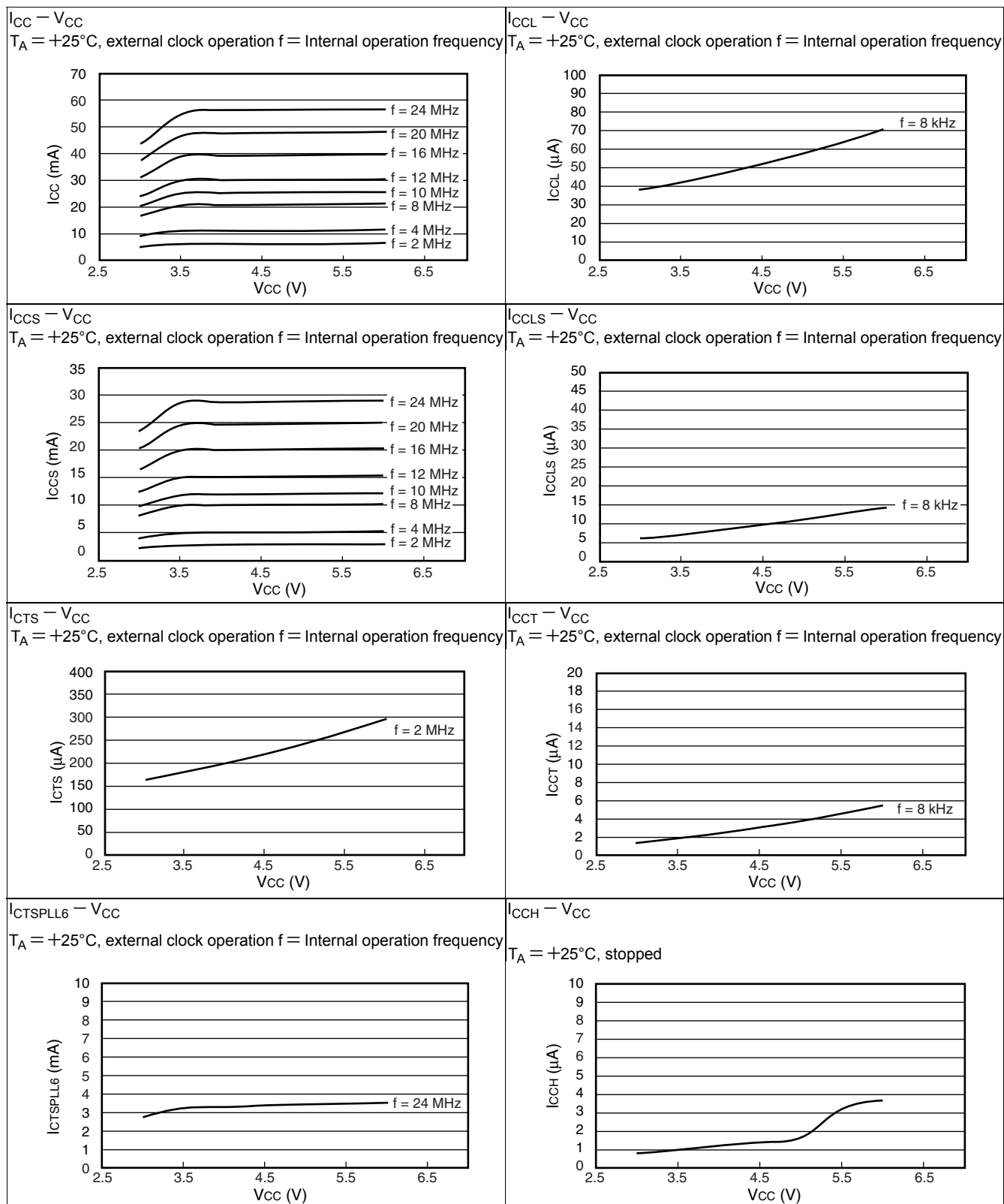
Note: : Use the values in the figure only as a guideline.

11.8 Flash Memory Program/Erase Characteristics

Parameter	Conditions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time	$T_A = +25^{\circ}\text{C}$ $V_{CC} = 5.0\text{ V}$	—	1	15	s	Excludes programming prior to erasure
Chip erase time		—	9	—	s	Excludes programming prior to erasure
Word (16-bit width) programming time		—	16	3600	μs	Except for the over head time of the system
Program/Erase cycle	—	10000	—	—	cycle	
Flash Data Retention Time	Average $T_A = +85^{\circ}\text{C}$	20	—	—	year	*

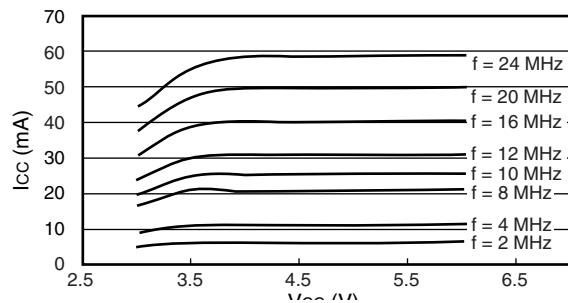
* : This value was converted from the results of evaluating the reliability of the technology (using Arrhenius equation to translate high temperature measurements into normalized value at $+85^{\circ}\text{C}$) .

■ MB90F349E, MB90F349ES, MB90F349CE, MB90F349CES

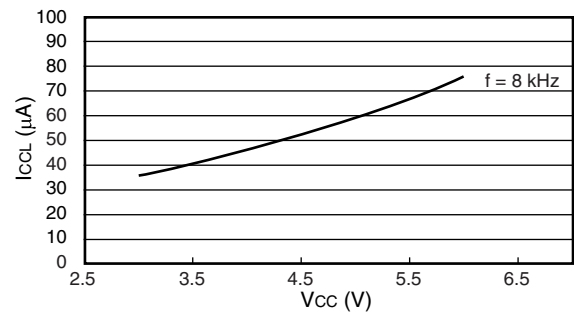


■ MB90F345E, MB90F345ES, MB90F345CE, MB90F345CES

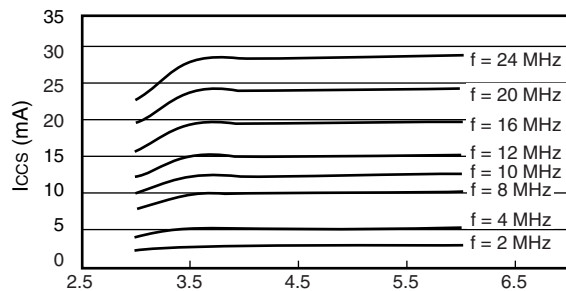
$I_{CC} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



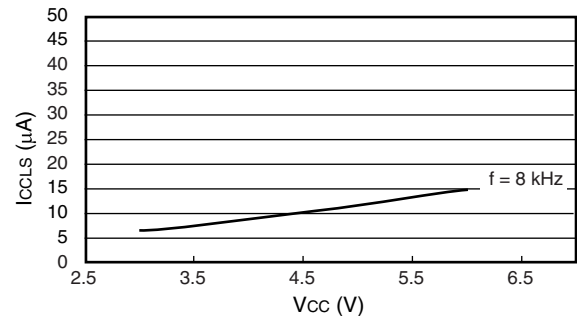
$I_{CCL} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



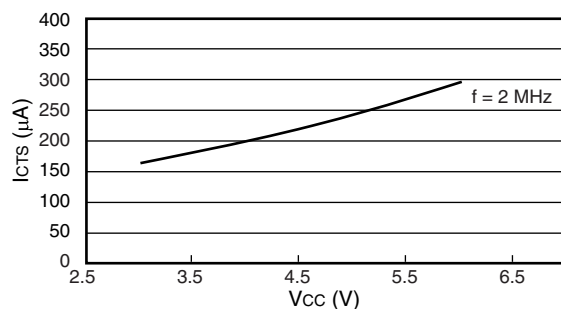
$I_{CCS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



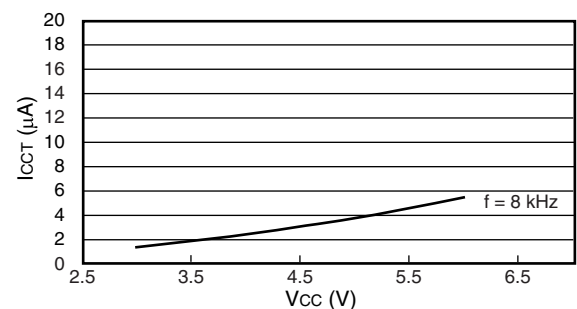
$I_{CCLS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



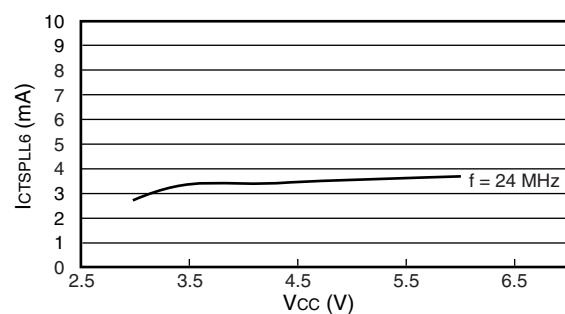
$I_{CTS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



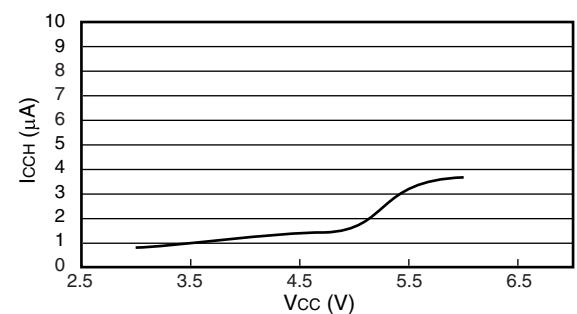
$I_{CCT} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



$I_{CTSPLL6} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation f = Internal operation frequency



$I_{CCH} - V_{CC}$
 $T_A = +25^\circ\text{C}$, stopped



13. Ordering Information

Part number	Package	Remarks
MB90F342EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F342ESPF		
MB90F342CEPF		
MB90F342CESPF		
MB90F342EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F342ESPMC		
MB90F342CEPMC		
MB90F342CESPMC		
MB90F345EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F345ESPF		
MB90F345CEPF		
MB90F345CESPF		
MB90F345EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F345ESPMC		
MB90F345CEPMC		
MB90F345CESPMC		
MB90F346EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F346ESPF		
MB90F346CEPF		
MB90F346CESPF		
MB90F346EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F346ESPMC		
MB90F346CEPMC		
MB90F346CESPMC		

(Continued)

(Continued)

Part number	Package	Remarks
MB90346EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90346ESPF		
MB90346CEPF		
MB90346CESPF		
MB90346EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90346ESPMC		
MB90346CEPMC		
MB90346CESPMC		
MB90347EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90347ESPF		
MB90347CEPF		
MB90347CESPF		
MB90347EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90347ESPMC		
MB90347CEPMC		
MB90347CESPMC		
MB90348EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90348ESPF		
MB90348CEPF		
MB90348CESPF		
MB90348EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90348ESPMC		
MB90348CEPMC		
MB90348CESPMC		
MB90349EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90349ESPF		
MB90349CEPF		
MB90349CESPF		
MB90349EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90349ESPMC		
MB90349CEPMC		
MB90349CESPMC		
MB90V340E-101CR	299-pin ceramic PGA (PGA-299C-A01)	For evaluation
MB90V340E-102CR		

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